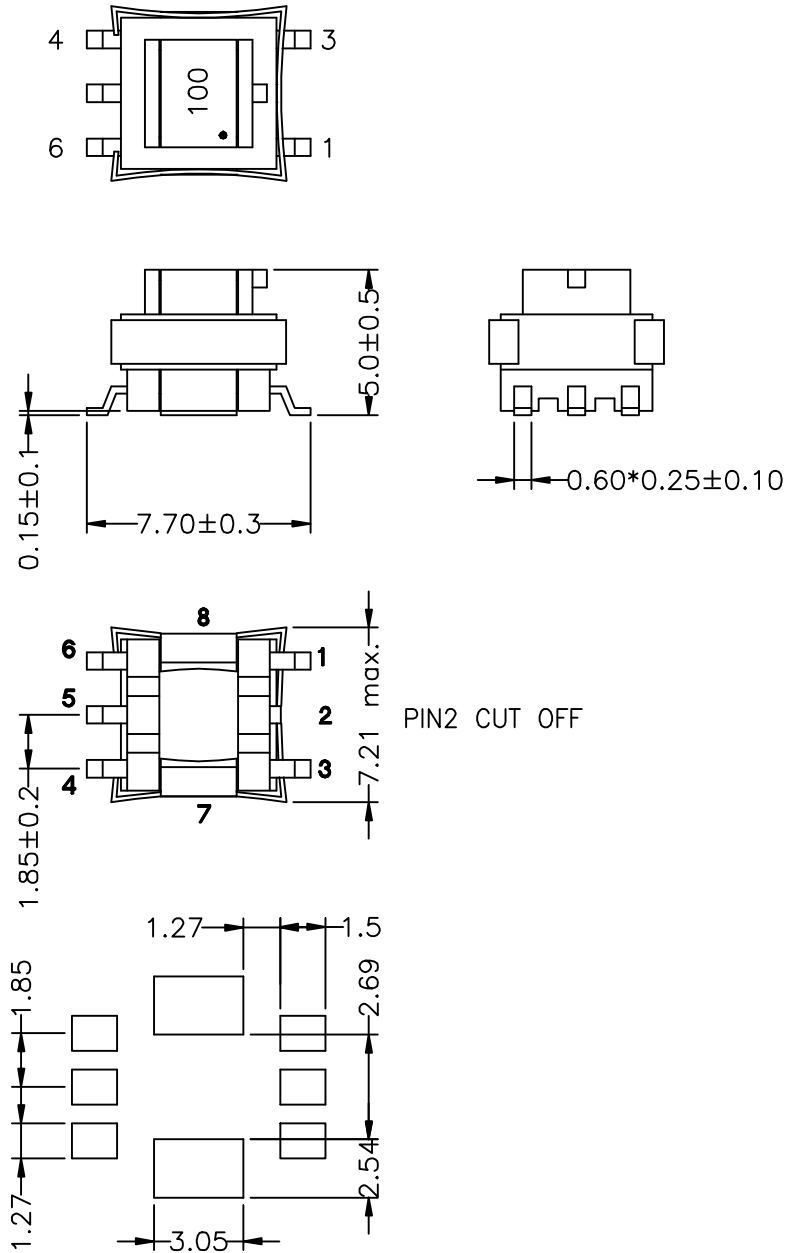
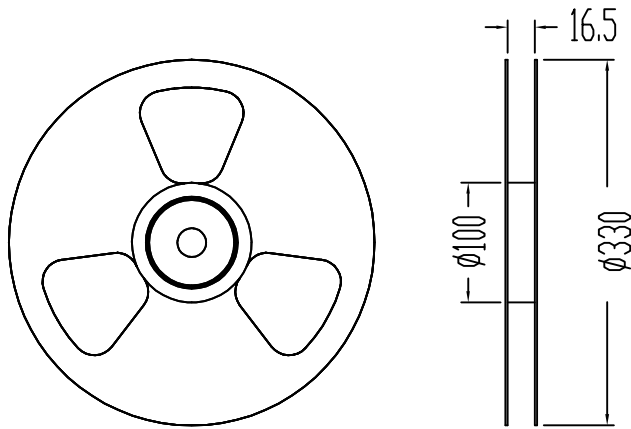
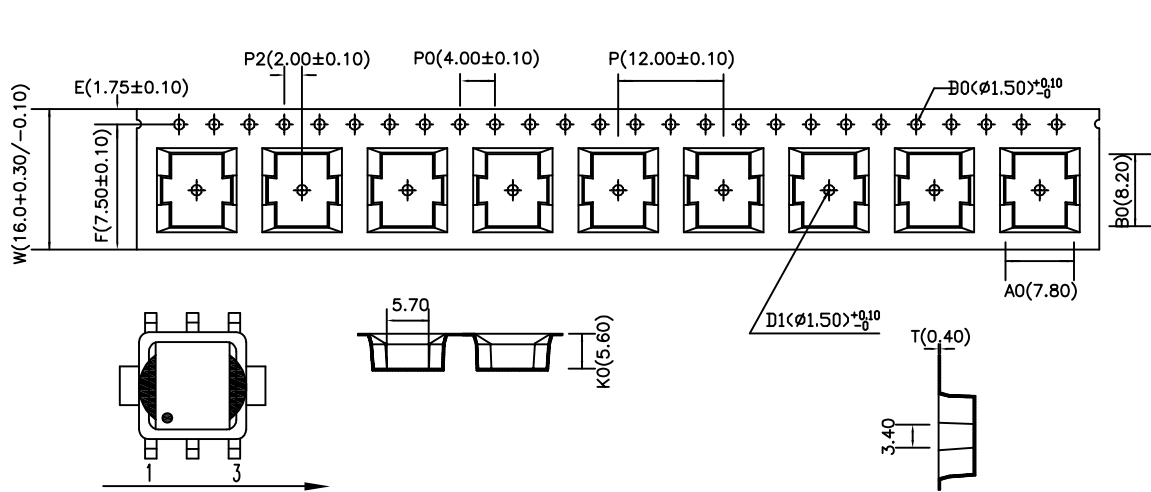




ELECTRICAL CHARACTERISTICS :

1. DCR : PIN 1-3 = 5.5Ω MAX.
PIN 8-7 = 0.75mΩ MAX.
2. INDUCTANCE (@10kHz, 0.1Vrms) : PIN 1-3 = 2mH MIN.
3. TURN RATIO (@10kHz, 1Vrms) : PIN 8-7 : 1-3 = 1 : 100 ±3%
4. HI-POT (@1KVAC, 3mA, 3SEC) : PRI - SEC
5. OPERATING TEMPERATURE RANGE : -40°C TO +125°C
6. RoHS COMPLIANT

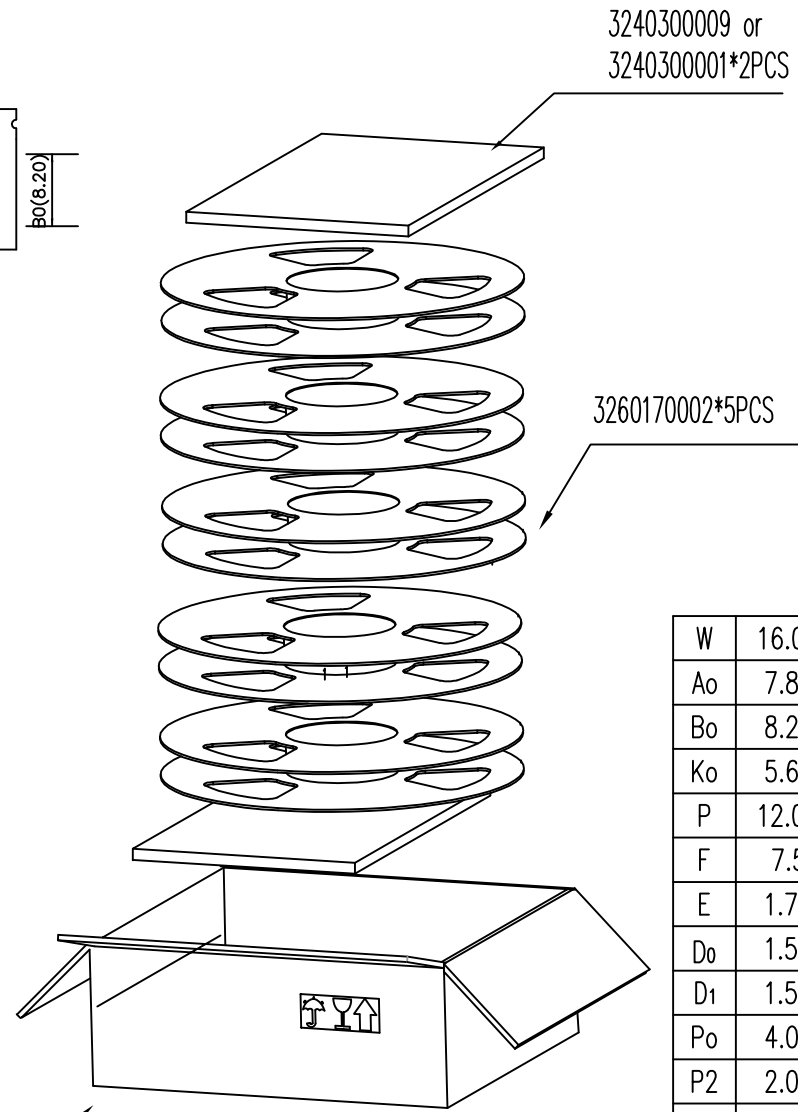
								TITLE TRANSFORMER	
								DWG. NO. ATS-1339R	
	RELEASE	05/10/2021	SHIRLEY	BETTY	BETTY	UNITS: M/M	SAFETY		SHEET 1 of 1
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE	P/N:	DRAW	
REVISIONS						05/10/21			SHIRLEY



ONE REEL 1000 PCS
ONE CARTON 5 REEL (5000 PCS)
每卷放干燥包1PC 用真空袋抽真空封口

2780000000 3255048421 OR 3255048420

3213434003*1PC
(CARTON)

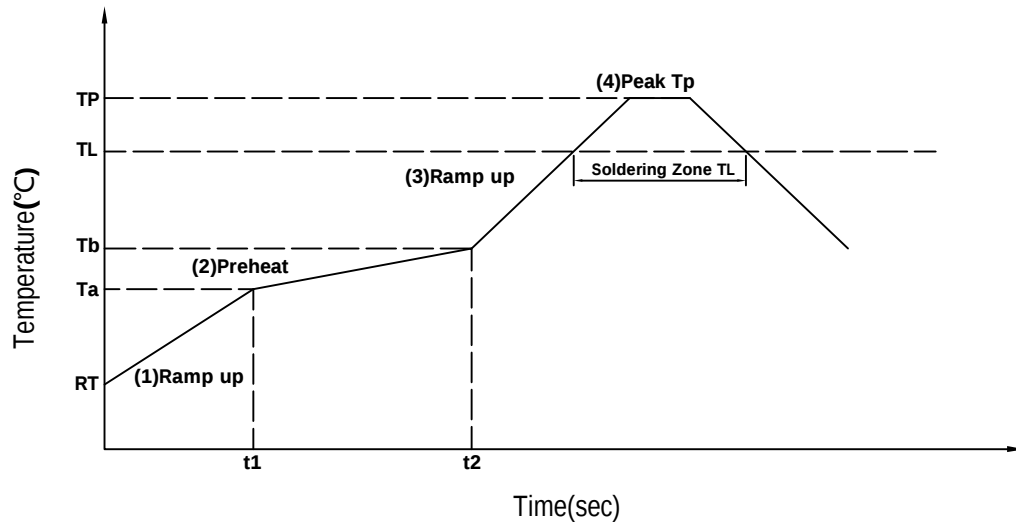


W	16.00	+0.30 -0.10
Ao	7.80	+0.10 -0.10
Bo	8.20	+0.10 -0.10
Ko	5.60	+0.10 -0.10
P	12.00	+0.10 -0.10
F	7.5	+0.10 -0.10
E	1.75	+0.10 -0.10
D0	1.50	+0.10 -0.00
D1	1.50	+0.1 -0.00
Po	4.00	+0.10 -0.10
P2	2.00	+0.10 -0.10
T	0.40	+0.05 -0.05

						TITLE	
						PACKING	
						DWG.NO	
						968SE69300	
						SHEET 1 OF 1	
						DRAW	
						杨明静	



Pb-free Soldering IR Reflow(SMD)



- 1,MSL Grade: 1 Level 2,Floor life: 2years 3,Condition:≤30°C RH 85%
2,Form-1(Reference JEDEC J-STD-020D Table 5-2)

IR reflow profile		Pb-free
step#	Profile Feature	Condition/Duration
step1	Ramp-up rate	3°C/second max
step2	Preheat:150°C-200°C(Ta-Tb)	t1-t2:60-120seconds
step3	Ramp-up rate(TL to Tp)	3°C/second max
	Temperature maintained above 217°C	60-150seconds
step4	Peak temperature(Tp)	260+0/-5°C
	Time within 5°C of actual peak temperature	30seconds max
Ramp-down rate(Tp to TL)		6°C/second max

- 3,Form-2(Reference JEDEC J-STD-020D Table 4-2)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6mm	260+0/-5°C	260+0/-5°C	260+0/-5°C
1.6mm-2.5mm	260+0/-5°C	250+0/-5°C	245+0/-5°C
>2.5mm	250+0/-5°C	245+0/-5°C	245+0/-5°C